





- DEPFET principle
- DEPFET as vertex detector for ILC
- Radiation exposure at ILC
- Spectroscopic investigations of irradiated DEPFET sensors

DEPFET - Depleted Field Effect Transistor

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- Combination of detector grade silicon with first p-FET amplification stage in each pixel
- **Potential minimum for electrons** is created under the channel by means of **sideward depletion** and an additional **n-doping**
- Electrons in the "internal gate" modulate the transistor current
- Signal charge is removed via a clear contact
- Large sensitive volume due to fully depleted bulk
- Low noise caused by a small input capacitance and internal amplification
- Transistor can be **switched off** by external gate charge collection is then still active!







Project review, Ringberg castle 23-25.04.2007

Radiation exposure at ILC

- Two main contributions to radiation:
- Neutrons backscattered from calorimeter
- ➢ e⁻ e⁺ pairs
 - Predominant source of background hits
 - Cause radiation damage

•Precision instrument requires high luminosity

Requires strong focused beams

Leads to high space charge density

 Beamstrahlungs photons due to e⁻ - e⁺ scattering

•Pair creation of e- - e+ pairs

Expected flux: $1.7*10^{12} \text{ e/cm}^2/\text{year}$ @ 10MeV [LDC DOD] $10^9 \text{ n/cm}^2/\text{year}$ @ 1MeV n equiv. [LDC DOD] $\sum (e^- + n)$ $8.5*10^{10}/\text{cm}^2/\text{year}$ @ 1MeV n equiv. [LDC DOD]

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Overview spectroscopy

•Irradiations made by Devis Contarado, Marco Battaglia and Piero Giubilato (LBNL)

- •Double pixel structures, 6µm gate length
- •Current based readout
- •Investigation with respect to:
 - •Electric characteristic
 - •Leakage
 - Spectroscopic performance



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Туре	Protons @ 30MeV	Neutrons @ 1-20MeV	Gammas – Co60
Dose	1.2 * 10 ¹² p/cm²	1.6 * 10 ¹¹ n/cm²	913kRad
1MeV n equivalent	3*10 ¹²	2.4*10 ¹¹	
ILC - expectation [LDC DOD]	1MeV n equivalent: 8.5 * 10 ¹⁰ /cm²/year		
ILC operation	35 years	3 years	

Influence of the radiation



NIEL (Non Ionizing Energy Loss)

- Damage to bulk
- Ionizing Energy Loss (charged particles)
 - Interface and bulk are damaged

Macroscopic effects:

- Thresholdvoltage shift
- Increase of leakage current from bulk und interface
- Increase of 1/f noise
- Change in effective dopand concentration



- Increase of subthreshold slope suggests an increase of 1/f noise
- Gm is noticeably reduced by 15%



•Dependence on operation voltages shows that there is additional contribution which is not bulk generated

•Thick detector - bulk generated current will decrease with thickness

•At 0°C around 20e/µs! -> L=50µs -> 31e contribution to ENC



p irradiation - spectroscopic performance



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n irradiation - electric characteristic





No thresholdvoltage shift

No visible increase of sub threshold slope



- Leakage current around **8.9e/µs @ 23°C**
- At low temperatures only slight deviations from unirradiated detector observed



Conclusion



• n-irradiated structure shows at low temperatures a performance similar to unirradiated structures

- No significant increase in 1/f and thermal noise
- Only bulk damage observed
- p-irradiated structure shows even at low temperature an increased noise
 - 1/f increased as one would expect from subthreshold slope
 - Decreased gm lead to an increase of white noise
- •BUT: both structures show nevertheless a good spectral resolution!
- Precise measurement of the spectral noise density will be done soon
- The DEPFET double pixel structure could be considered as radiation hard with respect to the ILC requirements
- •Irradiations of matrices will complete the picture





